

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
ATSUSHI EBARA	03/09/2018
KENICHI INOUE	03/09/2018
YOSHIYUKI MICHIAKI	03/09/2018
TAKAHIRO YAMADA	03/09/2018
MASAHIRO YOSHIDA	03/09/2018
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<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	15768065
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<b>ATTORNEY DOCKET NUMBER:</b>	18-184
<b>NAME OF SUBMITTER:</b>	GEORGE A. COURY
<b>SIGNATURE:</b>	/george a. coury/
<b>DATE SIGNED:</b>	04/13/2018
<b>Total Attachments: 2</b>	

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## ASSIGNMENT

In consideration of One Dollar (\$1.00), and other good and valuable consideration, the receipt of which is hereby acknowledged, We, the undersigned, Atsushi Ebara, a citizen of Japan and a resident of c/o DOWA ELECTRONICS MATERIALS CO., LTD., 14-1, Sotokanda 4-chome, Chiyoda-ku, Tokyo 101-0021, Japan, Kenichi Inoue, a citizen of Japan and a resident of c/o DOWA ELECTRONICS MATERIALS CO., LTD., 14-1, Sotokanda 4-chome, Chiyoda-ku, Tokyo 101-0021, Japan, Yoshiyuki Michiaki, a citizen of Japan and a resident of c/o DOWA ELECTRONICS MATERIALS CO., LTD., 14-1, Sotokanda 4-chome, Chiyoda-ku, Tokyo 101-0021, Japan, Takahiro Yamada, a citizen of Japan and a resident of c/o DOWA ELECTRONICS MATERIALS CO., LTD., 14-1, Sotokanda 4-chome, Chiyoda-ku, Tokyo 101-0021, Japan, and Masahiro Yoshida, a citizen of Japan and a resident of c/o DOWA ELECTRONICS MATERIALS CO., LTD., 14-1, Sotokanda 4-chome, Chiyoda-ku, Tokyo 101-0021, Japan, hereby sell, assign and transfer to DOWA ELECTRONICS MATERIALS CO., LTD., a corporation of Japan, having a place of business at 14-1, Sotokanda 4-chome, Chiyoda-ku, Tokyo 101-0021, Japan, its successors, assigns and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the following application for United States Letters Patent:

Serial No.: 15/768,065

Filing Date: April 13, 2018

Title: SILVER POWDER AND METHOD FOR PRODUCING SAME

Inventors: Atsushi Ebara et al.

Attorney's Docket No. 18-184

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee,

its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

(L.S.) Atsushi Ebara March 9, 2018  
Atsushi Ebara (Date)

(L.S.) Kenichi Inoue March 9, 2018  
Kenichi Inoue (Date)

(L.S.) Yoshiyuki Michiaki March 9, 2018  
Yoshiyuki Michiaki (Date)

(L.S.) Takahiro Yamada March 9, 2018  
Takahiro Yamada (Date)

(L.S.) Masahiro Yoshida March 9, 2018  
Masahiro Yoshida (Date)